

**Amendments to the Specification**

Please amend the specification as follows:

Please replace paragraph number [0029] with the following rewritten paragraph:

A conductive path is formed from one major surface 13 to the other major surface 15 of the gas separator plate ~~[[3]]~~ 103 through the first conductive fillers 17, the first interconnecting body 25, the second conductive fillers 19, the second interconnecting body 125 and the third conductive fillers 117. The first 17 and third 117 fillers extend out of the respective separator plate surface 13, 15 or the contact pads 21, 23 are formed on respective fillers 17, 117, as shown in Figure 3. It should be noted that the interconnect 100 may have more than three layers by repeating the structure shown in Figure 3.